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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

January 7, 2002

Applicants: Hiromichi INAGAKI et al  
For: PACKAGING MATERIAL AND PACKAGED PRODUCT  
Serial No.: 10/009 205 Group: Unknown  
Filed: December 4, 2001 Examiner: Unknown  
International Application No.: PCT/JP01/03563  
International Filing Date: April 25, 2001  
Atty. Docket No.: Komatsu Case 261

Assistant Commissioner for Patents  
Washington, DC 20231

**SECOND AMENDMENT BEFORE FIRST OFFICE ACTION**

Sir:

Prior to issuance of the first Office Action in the  
above-identified application, kindly enter the following:

IN THE CLAIMS

Please amend Claims 1-5 as follows. A marked-up copy is  
also enclosed herewith.

1. (Amended) A packaging material using a film  
laminate in which a heat sealing agent with a low melting  
point is applied to a prescribed zone of an oriented film made  
of a synthetic resin, a cutting line is cut in the oriented  
film in the form of a solid or broken line passing through the  
zone coated with the heat sealing agent, and a cast film made  
of a synthetic resin and having heat sealing properties is  
affixed to the oriented film.

2. (Amended) A packaging material using a film  
laminate in which a release agent is applied to a prescribed  
zone of an oriented film made of a synthetic resin, a cutting  
line is cut in the oriented film in the form of a solid or